

1MBH75D-060S

Molded IGBT

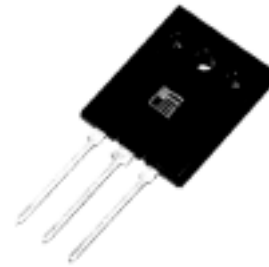
600V / 75A Molded Package

■ Features

- Small molded package
- Low power loss
- Soft switching with low switching surge and noise
- High reliability, high ruggedness (RBSOA, SCSOA etc.)
- Comprehensive line-up

■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply

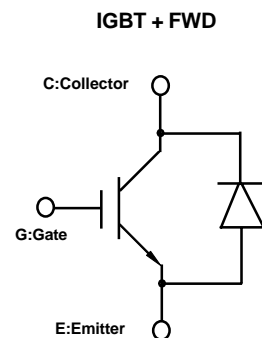


■ Maximum ratings and characteristics

● Absolute maximum ratings (Tc=25°C)

Item	Symbol	Rating	Unit		
Collector-Emitter voltage	V _{CES}	600	V		
Gate-Emitter voltage	V _{GES}	±20	V		
Collector current	DC	T _c =25°C	I _{C25}	83	A
		T _c =100°C	I _{C100}	75	A
	1ms	T _c =25°C	I _{CP}	225	A
Max. power dissipation (IGBT)	P _C	310	W		
Max. power dissipation (FWD)	P _C	180	W		
Operating temperature	T _j	+150	°C		
Storage temperature	T _{stg}	-40 to +150	°C		
Screw torque	-	58.8 to 78.4	N·cm		

■ Equivalent Circuit Schematic



● Electrical characteristics (at Tc=25°C unless otherwise specified)

Item	Symbol	Characteristics			Conditions	Unit	
		Min.	Typ.	Max.			
Zero gate voltage collector current	I _{CES}	-	-	1.0	V _{GE} =0V, V _{CES} =600V	mA	
Gate-Emitter leakage current	I _{GES}	-	-	10	V _{CE} =0V, V _{GE} =±20V	μA	
Gate-Emitter threshold voltage	V _{GE(th)}	4.0	5.0	6.0	V _{CE} =20V, I _C =75mA	V	
Collector-Emitter saturation voltage	V _{CE(sat)}	-	2.4	2.9	V _{GE} =15V, I _C =75A	V	
Input capacitance	C _{ies}	-	3700	-	V _{GE} =0V	pF	
Output capacitance	C _{oes}	-	350	-	V _{CE} =25V		
Reverse transfer capacitance	C _{res}	-	190	-	f=1MHz		
Switching Time	Turn-on time	t _{on} *	-	0.15	-	V _{CC} =300V, I _C =75A	μs
		t _r *	-	0.09	-	V _{GE} =±15V	
		t _{rr2}	-	0.03	-	R _G =24 ohm	
	Turn-off time	t _{off}	-	0.50	0.62	(Half Bridge)	μs
		t _f	-	0.10	0.17	Inductance Load	
		t _{rr}	-	0.10	0.17	Inductance Load	
	Turn-on time	t _{on} *	-	0.15	-	V _{CC} =300V, I _C =75A	μs
		t _r *	-	0.09	-	V _{GE} =+15V	
t _{rr2}		-	0.03	-	R _G =6 ohm		
Turn-off time	t _{off}	-	0.50	0.62	(Half Bridge)	μs	
	t _f	-	0.10	0.17	Inductance Load		
	t _{rr}	-	0.10	0.17	Inductance Load		
FWD forward on voltage	V _F	-	2.0	2.5	I _F =75A, V _{GE} =0V	V	
Reverse recovery time	t _{rr}	-	0.06	0.10	I _F =75A, V _{GE} =-10V, V _R =300V, di/dt=100A/μs	μs	

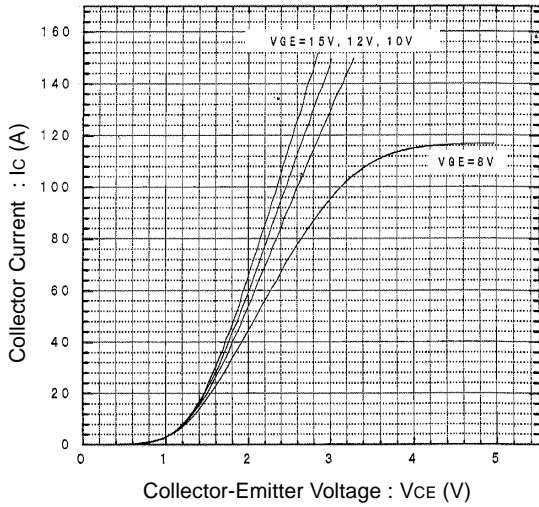
*Turn-on characteristics include t_{rr2}. See a figure in next page.

● Thermal resistance characteristics

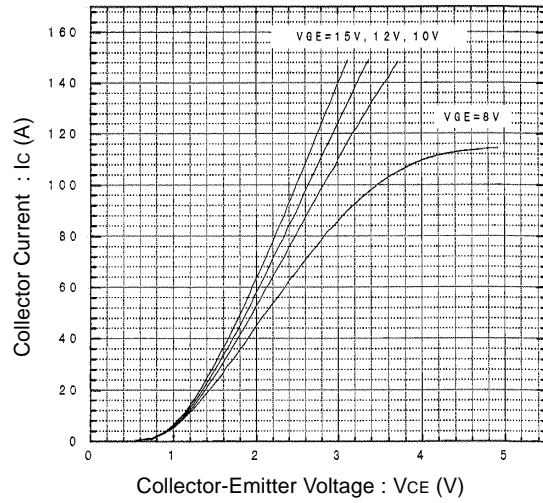
Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	R _{th(j-c)}	-	-	0.40	IGBT	°C/W
	R _{th(j-c)}	-	-	0.69	FWD	°C/W

Characteristics

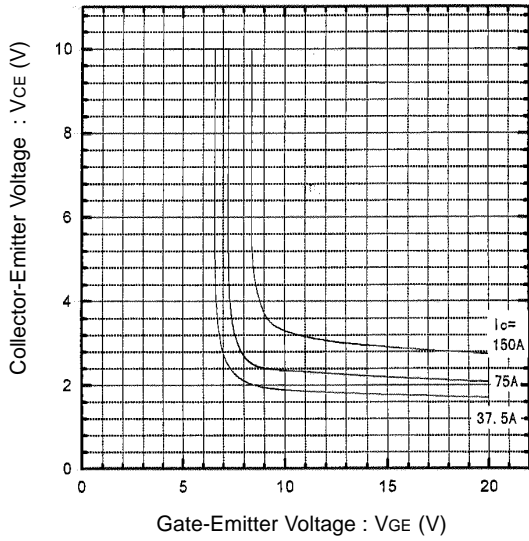
Collector current vs. Collector-Emitter voltage
T_j=25°C



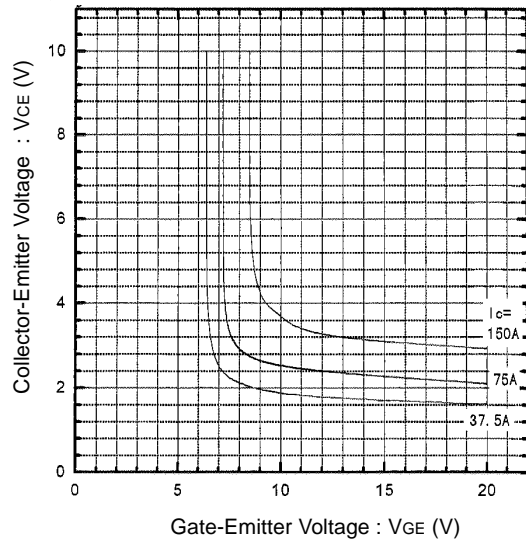
Collector current vs. Collector-Emitter voltage
T_j=125°C



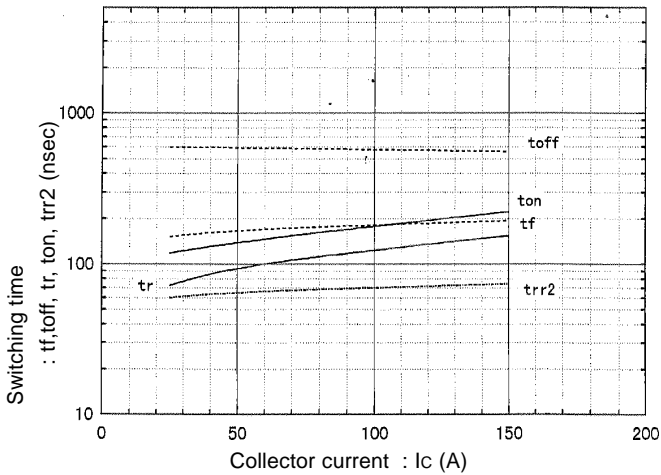
Collector-Emitter voltage vs. Gate-Emitter voltage
T_j=25°C



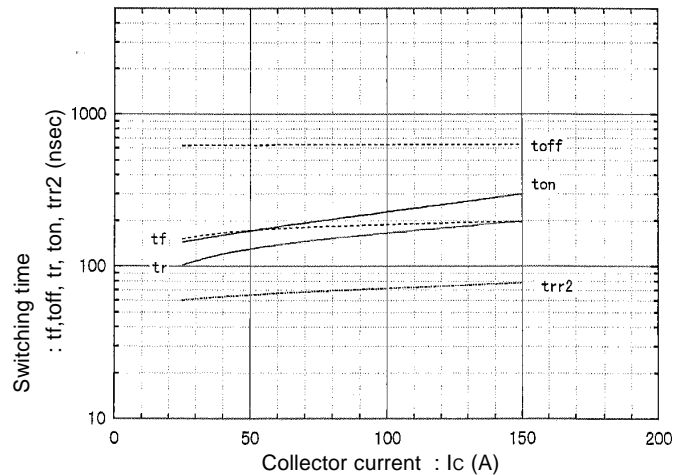
Collector-Emitter voltage vs. Gate-Emitter voltage
T_j=125°C



Switching time vs. Collector current
V_{CC}=300V, R_G=6Ω, V_{GE}=+15V, T_j=125°C



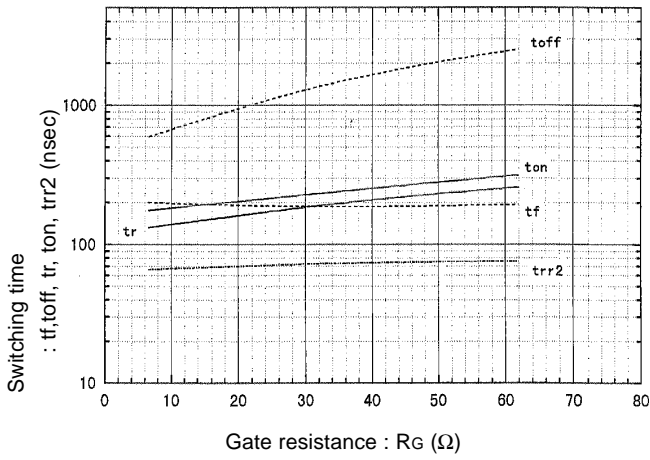
Switching time vs. Collector current
V_{CC}=300V, R_G=24Ω, V_{GE}=±15V, T_j=125°C



Characteristics

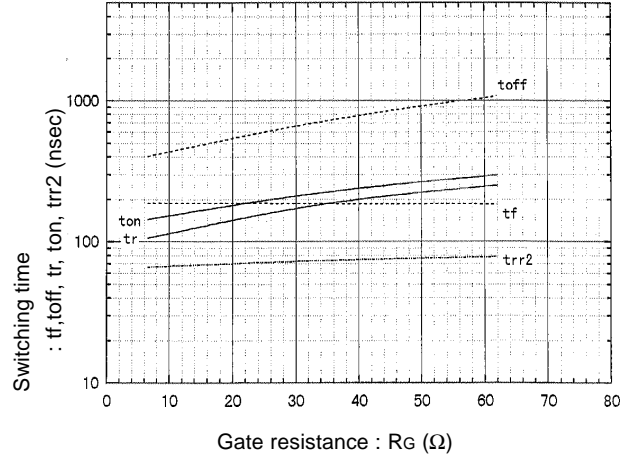
Switching time vs. RG

VCC=300V, IC=75A, VGE=+15V, Tj=125°C



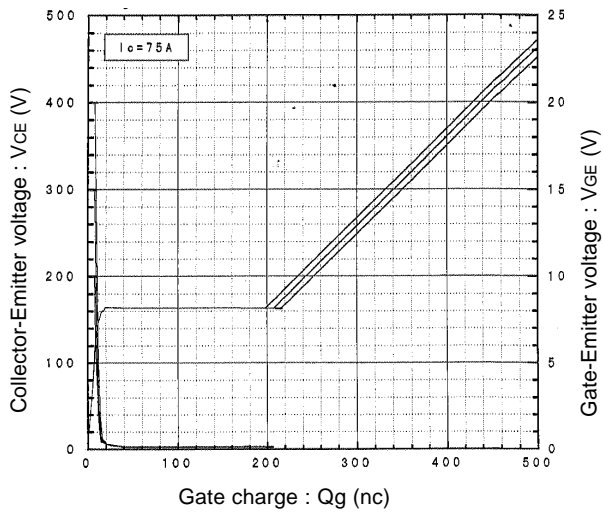
Switching time vs. RG

VCC=300V, IC=75A, VGE=±15V, Tj=125°C



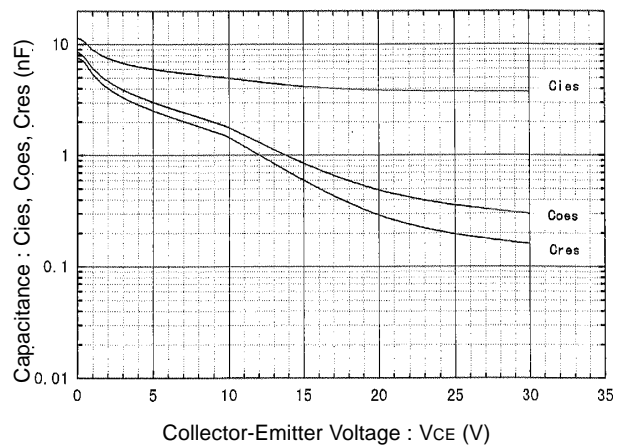
Dynamic input characteristics

Tj=25°C



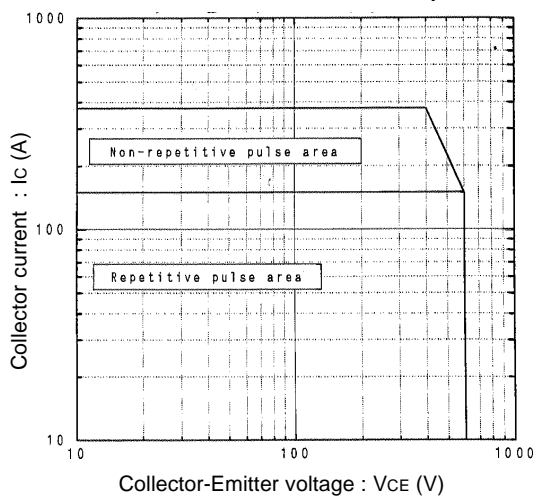
Capacitance vs. Collector-Emitter voltage

Tj=25°C

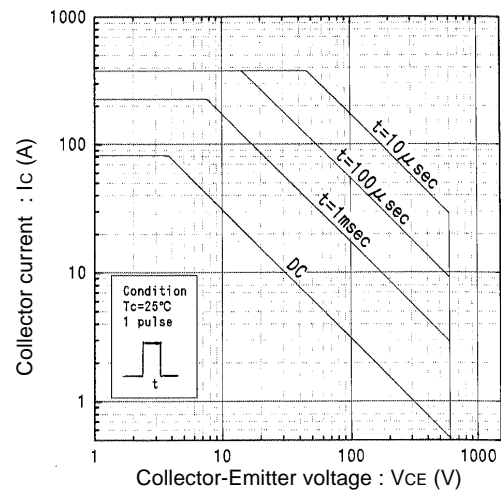


Reverse Biased Safe Operating Area

RG=6Ω, +VGE≤20V, -VGE=15V, Tj≤125°C



Forward Bias Safe Operating Area



■ Characteristics

